# JOINT BAY SEMICONDUCTOR CO.,LTD

") &? < N" &5 "DK A "6 i W\_" 87 #87 "7 cbj YfhYf



## FEATURES

- Output voltage: 3.3V, 5.0V, 12V, and adjustable output version
- Adjustable version output voltage range:1.23V to 37V±4%
- 52KHz±15% fixed switching frequency
- Voltage mode non-synchronous PWM control
- Thermal-shutdown and current-limit protection
- ON/OFF shutdown control input
- Operating voltage can be up to 40V
- Output load current: 2A
- Low power standby mode
- Built-in switching transistor on chip
- SOP8-EP package

#### APPLICATIONS

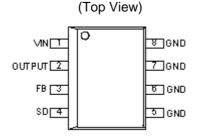
- Simple High-efficiency step-down regulator
- On-card switching regulators
- Positive to negative converter

#### GENERAL DESCRIPTION

The LSP3127 series are monolithic IC that design for a step-down DC/DC converter, and own the ability of driving a 2A load without additional transistor component. Due to reducing the number of external component, the board space can be saved easily. The external shutdown function can be controlled by logic level and then come into standby mode. The internal compensation makes feedback control have good line and load regulation without external design. Regarding protected function, thermal shutdown is to prevent over temperature operating from damage, and current limit is against over current operating of the output switch. The LSP3127 series operates at a switching frequency of 52 KHz thus allowing smaller sized filter components than what would be needed with lower frequency switching regulators. Other features include a guaranteed ±4% tolerance on output voltage under specified input voltage and output load conditions, and ±15% on the oscillator frequency. The output version included fixed 3.3V, 5V, 12V, and an adjustable type. The package is available in a standard SOP8-EP package.

#### PIN CONFIGURATION

SOP8-EP

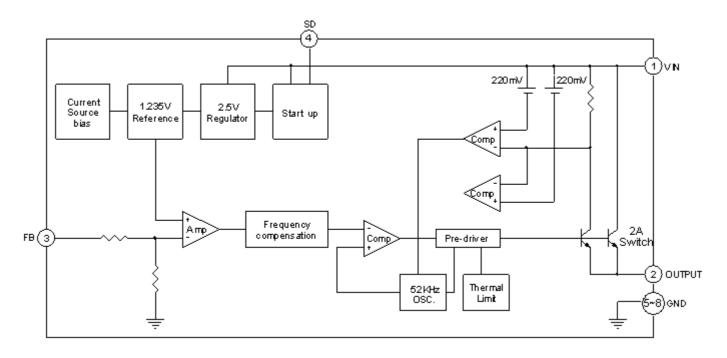


#### PIN DESCRIPTION

Name	No.	Description			
VIN	1	Operating Voltage Input			
OUTPUT	2	Switching Output			
FB	3	utput Voltage Feedback Control			
SD	4	Dn/Off Shutdown			
GND	5	Ground			
GND	6	Ground			
GND	7	Ground			
GND	8	Ground			



## BLOCK DIAGRAM



#### ABSOLUTE MAXIMUM RATINGS

Symbol	Paramrter	Rating	Unit	
V <sub>CC</sub>	Supply Voltage	+45	V	
V <sub>SD</sub>	ON/OFF Pin input Voltage	-0.3 to +25	V	
V <sub>FB</sub>	Feedback Pin Voltage	-0.3 to +25	V	
V <sub>OUT</sub>	Output Voltage to Ground	-1	V	
P <sub>D</sub>	Power Dissipation	Internally Limited	W	
T <sub>ST</sub>	Storage Temperature	-65 to +150		
T <sub>OP</sub>	Operating Temperature	-40 to +125		
V <sub>OP</sub>	Operating Voltage	+4.5 to +40	V	

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#### ■ ELECTRICAL CHARACTERISTICS (ALL OUTPUT VOLTAGE VERSIONS) Unless otherwise specified, V<sub>IN</sub>=12V for 3.3V.5V, adjustable version and V<sub>IN</sub>=24V for the 12V version, I<sub>LOAD</sub>=0.5A

Symbol	Paramrter	Cond	litions	Min.	Тур.	Max.	Unit	
I <sub>B</sub>	Feedback bias current	V <sub>FB</sub> =1.3V(A version only	,		40	50 100	nA	
F <sub>osc</sub>	Oscillator frequency		-	44 <b>38</b>	52	60 66	KHz	
V <sub>SAT</sub>	Saturation voltage	I <sub>OUT</sub> =2A no outsi V <sub>FB</sub> =0V forc	de circuit ce driver on		1.4	1.8	V	
DC	Max.Duty Cycle(ON)		V <sub>FB</sub> =0V force driver on V <sub>FB</sub> =12V force driver off			100	%	
DC	Min.Duty Cycle(OFF)	V <sub>FB</sub> =12V fo						
I <sub>CL</sub>	Current limit	no outside o	Peak current no outside circuit V <sub>FB</sub> =0V force driver on		5.8		A	
۱ <sub>L</sub>	Output=0 Output leakage	no outsi V <sub>FB</sub> =12V fo	de circuit rce driver off			2	mA	
	Output=-1 current	V <sub>IN</sub> =40V				30	mA	
lq	Quiescent Current	V <sub>FB</sub> =12V fo	rce driver off		5	10	mA	
I <sub>STBY</sub>	Standby Quiesier Current	t ON/OFF V <sub>IN</sub> =40V	Pin=5V		80	200	μA	
V <sub>IL</sub>	ON/OFF pin logic inpu	t Low(regu	ultaor ON)		1.4	0.8	V	
$V_{\text{IH}}$	threshold voltage	High(regu	ltaor OFF)	2.4				
I <sub>H</sub>	ON/OFF pin logic inpu current	t V <sub>LOGIC</sub> =2	V <sub>LOGIC</sub> =2.5V(OFF)			30	μA	
١L	ON/OFF pin inpu current	t V <sub>LOGIC</sub> =0.	V <sub>LOGIC</sub> =0.5V(ON)			10	μΑ	
$\theta_{\text{JC}}$	Thermal Resistence	SOP8-EP	SOP8-EP Junction to case		10		/W	
$\theta_{JA}$	Thermal Resistence With copper area c approximately 3 in <sup>2</sup>		lunction		50		/W	

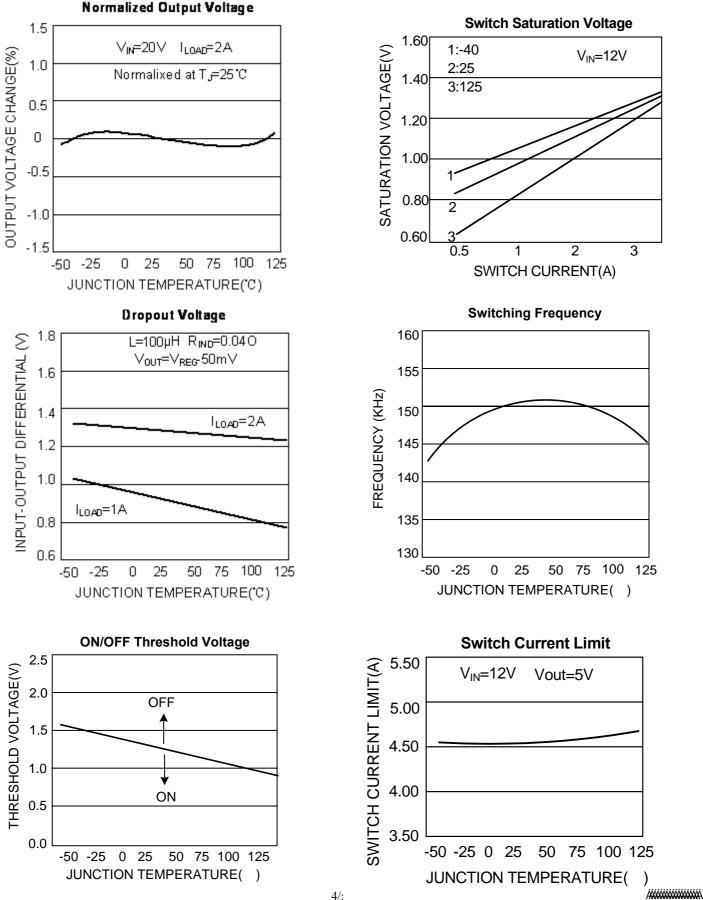
## ELECTRICAL CHARACTERISTICS (CONTINUED)

Parameter Sy		mbol	Test Conditions	Min.	Тур.	Max.	Unit
Output			4.5V ≤V <sub>IN</sub> ≤22V	1.193	4.00	1.267	
Feedback	LSP3127-ADJ	V <sub>FB</sub>	0.2A ≤I <sub>LOAD</sub> ≤2A V <sub>OUT</sub> Programmed for 3V	1.18	1.23	1.28	V
Efficiency		η	$V_{IN}$ =12V, $I_{LOAD}$ = 2A	76			%
Output		V <sub>FB</sub>	4.5V ≤V <sub>IN</sub> ≤22V	3.168	3.3	3.432	V
Feedback	LSP3127-3.3V	V FB	0.2A ≤I <sub>LOAD</sub> ≤2A	3.135	5.5	3.465	v
Efficiency	LOF 3127-3.3V	η	$V_{IN}$ =12V, $I_{LOAD}$ = 2A	78			%
Output		V <sub>FB</sub>	7V ≤V <sub>IN</sub> ≤22V	4.8	5	5.2	V
Feedback	LSP3127-5.0V	V FB	0.2A ≤I <sub>LOAD</sub> ≤2A	4.75	5	5.25	
Efficiency		η	$V_{IN} = 12V, I_{LOAD} = 2A$	83			%
Output Feedback		V V <sub>FB</sub>	15V ≤V <sub>IN</sub> ≤22V	11.52	12	11.4	V
Feeuback	LSP3127-12V		0.2A ≤I <sub>LOAD</sub> ≤2A	12.48		12.6	
Efficiency		η	$V_{IN} = 15V, I_{LOAD} = 2A$	90			%

Specifications with boldface are for full operating temperature range, the other type are for T<sub>J</sub>=25°C

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## TYPICAL PERFORMANCE CHARACTERISTICS

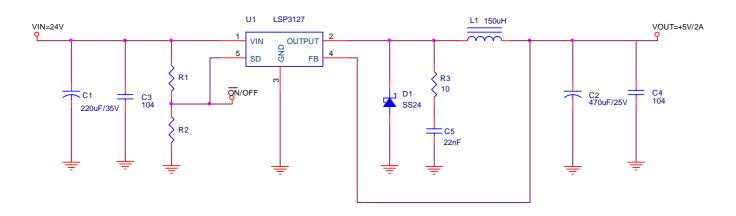


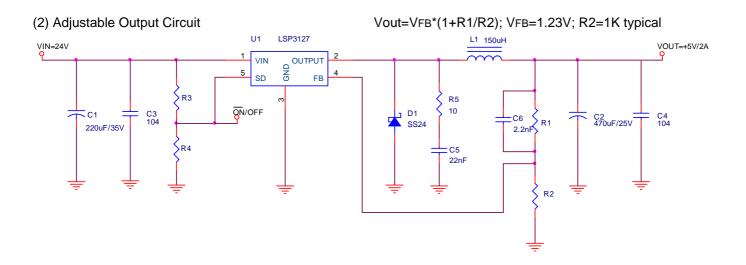


LSP312+

TYPICAL APPLICATION CIRCUITS

(1) Fixed Output Circuit





## FUNCTION DESCRIPTION

## **Pin Function**

#### $V_{\text{IN}}$

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

#### Ground

Circuit ground.

#### Output

Internal switch. The voltage at this pin switches between  $(V_{IN} - V_{SAT})$  and approximately – 0.5V, with a duty cycle of approximately  $V_{OUT}$  /  $V_{IN}$ . To minimize coupling to sensitive circuitry, the PC board copper area connected to this pin should be kept a minimum.

#### Feedback

Senses the regulated output voltage to complete the feedback loop.

Add C6 capacitor (Cff:feed forward capacitor) for ADJ version to add the control loop stability.

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#### ON/OFF

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 150uA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of 25V) shuts the regulator down. If this shutdown feature is not needed, the ON/OFF pin can be wired to the ground pin or it can be left open, in either case the regulator will be in the ON condition.

#### **Thermal Considerations**

The SOP8L package needs a heat sink under most conditions. The size of the heatsink depends on the input voltage, the output voltage, the load current and the ambient temperature. The LSP3127 junction temperature rises above ambient temperature for a 2A load and different input and output voltages. The data for these curves was taken with the LSP3127(SOP8L package) operating as a buck-switching regulator in an ambient temperature 25 (still air). These temperature increments are all approximate and are affected by many factors. Higher ambient temperatures requires more heat sinker.

For the best thermal performance, wide copper traces and generous amounts of printed circuit board copper should be used in the board layout. (One exception is the output (switch) pin, which should not have large areas of copper.) Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

Package thermal resistance and junction temperature increments are all approximate. The increments are affected by a lot of factors. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are, trace width, total printed circuit copper area, copper thickness, single or double-sided, multi-layer board and the amount of solder on the board.

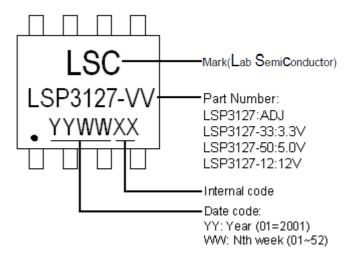
The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode will add heat to the PC board and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.



## ORDERING INFORMATION

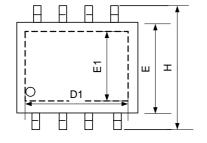
	LSP3127XXX	X	
F Package: S:SOP8-EP	Output Voltage: Blank: ADJ 33: 3.3V 50: 5.0V 12: 12V	Packing: Blank: Tube or Bulk A: Tape & Reel	Temperature Grade: E:-40~125°C

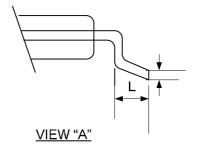
#### MARKING INFORMATION

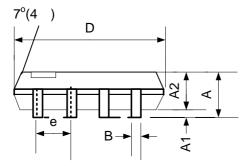


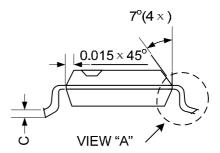


# PACKAGE INFORMATION









Symbol	Dimensions In Millimeters			Dimensions In Inches		
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.
А	1.35	1.60	1.75	0.053	0.063	0.069
A1	0.05		0.15	0002		0.006
A2	1.35	1.45	1.55	0.053	0.057	0.061
В	0.33	0.41	0.51	0.013	0.016	0.020
С	0.19	0.20	0.25	0.0075	0.008	0.010
D	4.70	4.90	5.10	0.185	0.196	0.200
D1	3.202		3.402	0.126		0.134
E	3.80	3.90	4.00	0.148	0.154	0.160
E1	2.313		2.513	0.091		0.099
е	1.27TYP.			0.050TYP.		
Н	5.80	5.99	6.30	0.228	0.236	0.248
Ĺ	0.38	0.71	1.27	0.015	0.028	0.050
θ	0°		8°	0°		8°